



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = 25°C
24V	$15m\Omega @ V_{GS} = 4.5V$	6.5A
24 V	$20m\Omega$ @ $V_{GS} = 2.5V$	5.6A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

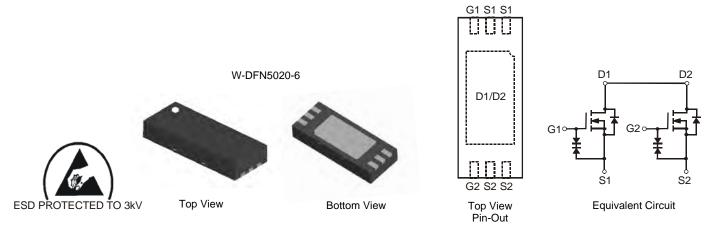
- DC-DC Converters
- Power management functions

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected up to 3kV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: W-DFN5020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.03 grams (approximate)



Ordering Information (Note 4)

1		
Part Number	Case	Packaging
DMG5802LFX-7	W-DFN5020-6	3000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



ME = Product Type Marking Code YM = Date Code Marking Y = Year (ex: X = 2010)

M = Month (ex: 9 = September)

Date Code Key

Year	2010	20	11	2012	2013	20	14	2015	2016	20	17	2018
Code	X	`	1	Z	Α		В	С	D	I	Ξ	F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteri	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	24	V		
Gate-Source Voltage	V_{GSS}	±12	V		
Continuous Drain Current (Note 5) V _{GS} = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	6.5 5.2	А
Continuous Drain Current (Note 5) V _{GS} = 2.5V	I _D	5.6 4.5	А		
Pulsed Drain Current (Note 6)	I _{DM}	70	А		

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 5)	P _D	0.98	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	$R_{\theta JA}$	126.5	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

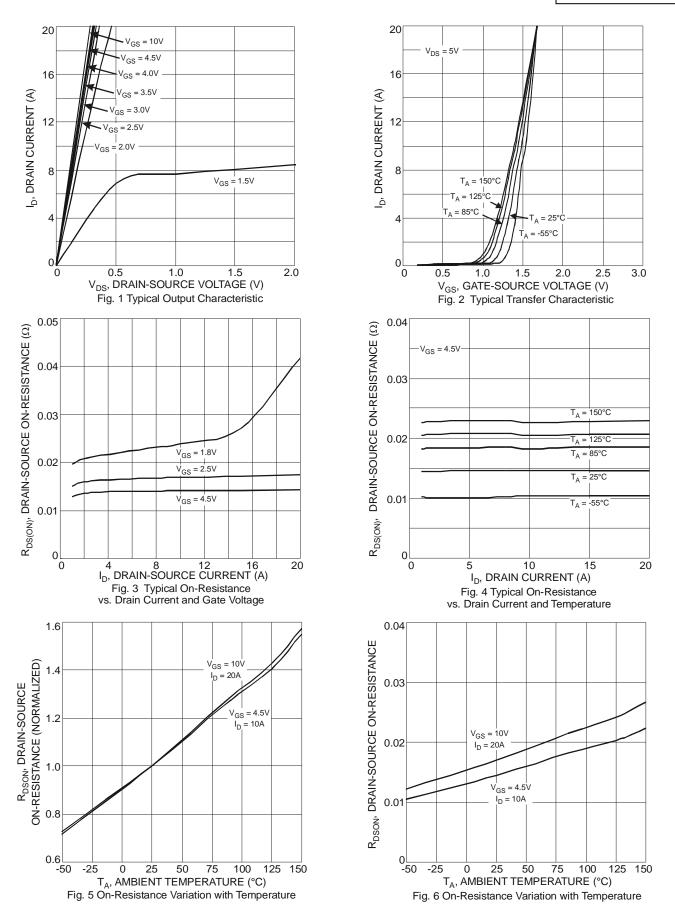
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	24	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	-	-	1.0	μΑ	$V_{DS} = 24V$, $V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	-	±10	μΑ	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)					-	
Gate Threshold Voltage	V _{GS(th)}	0.6	0.9	1.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		1	11	15		$V_{GS} = 4.5V, I_D = 6.5A$
Static Drain-Source On-Resistance	В	-	12	17	mΩ	$V_{GS} = 4V, I_D = 5.6A$
Static Drain-Source On-Resistance	R _{DS} (ON)	-	13	18	11177	$V_{GS} = 3.1V, I_D = 5.6A$
		-	14	20		$V_{GS} = 2.5V, I_D = 5.6A$
Forward Transfer Admittance	Y _{fs}	-	17	-	S	$V_{DS} = 5V, I_{D} = 6.5A$
Diode Forward Voltage	V _{SD}	-	0.6	0.9	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C_{iss}	ı	1066.4	1		\\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Output Capacitance	Coss	-	132.0	-	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	127.1	-		1 = 1.001112
Gate Resistance	R_q	-	1.47	-	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge V _{GS} = 4.5V	Q_g	-	14.5	-		$V_{GS} = 4.5V, V_{DS} = 15V, I_D = 5.8A$
Total Gate Charge V _{GS} = 10V	Qq	-	31.3	-	nC	101/11/
Gate-Source Charge	Qgs	-	2.0	-	nc nc	$V_{GS} = 10V, V_{DS} = 15V,$
Gate-Drain Charge	Q _{qd}	-	3.1	-		$I_D = 5.8A$
Turn-On Delay Time	t _{D(on)}	-	3.69	-	ns	
Turn-On Rise Time	t _r	-	13.43	-	ns	V _{GS} = 10V, V _{DS} = 15V,
Turn-Off Delay Time	t _{D(off)}	-	32.18	-	ns	$R_L = 2.1\Omega$, $R_G = 3\Omega$
Turn-Off Fall Time	t _f	-	22.45	-	ns	

Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- Repetitive rating, pulse width limited by junction temperature.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.







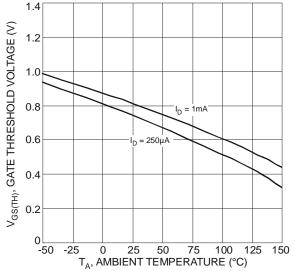
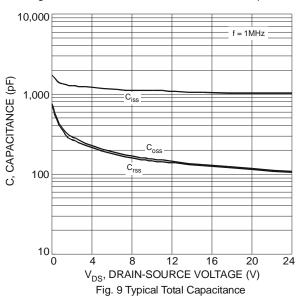
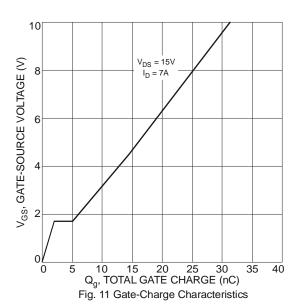
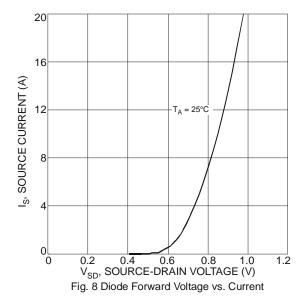
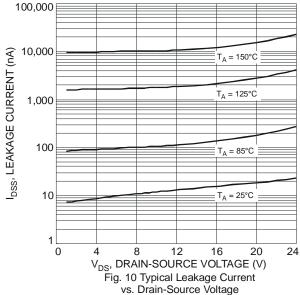


Fig. 7 Gate Threshold Variation vs. Ambient Temperature

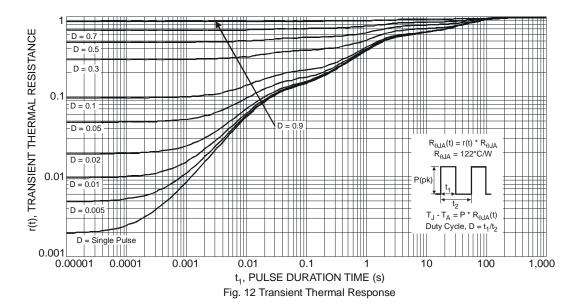






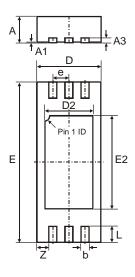






Package Outline Dimensions

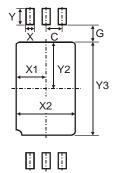
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	W-DFN5020-6							
Dim	Min	Max	Тур					
Α	0.75	0.85	0.80					
A1	0	0.05	0.02					
A3	_	_	0.15					
b	0.20	0.30	0.25					
D	1.90	2.10	2.00					
D2	1.40	1.60	1.50					
е	_	-	0.50					
Е	4.90	5.10	5.00					
E2	2.80	3.00	2.90					
L	0.35	0.65	0.50					
Z	_	-	0.375					
All	All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.50
G	0.35
Х	0.35
X1	0.90
X2	1.80
Υ	0.70
Y2	1.60
Y3	3.20



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